

United States Patent and Trademark Office



UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/748,480	12/30/2003	Robert F. Mortan	TI-36812 (032350.B572)	8732
23494 7:	590 08/11/2006		EXAMINER	
TEXAS INSTRUMENTS INCORPORATED			HOANG, QUOC DINH	
P O BOX 6554 DALLAS, TX	-	ART UNIT	PAPER NUMBER	
			2818	
			DATE MAILED: 08/11/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/748,480	MORTAN, ROBERT F.					
Office Action Summary	Examiner	Art Unit					
	Quoc D. Hoang	2818					
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address					
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	TE OF THIS COMMUNICATION 6(a). In no event, however, may a reply be timil apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	I. lely filed the mailing date of this communication. O (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 01 Ju	Responsive to communication(s) filed on 01 June 2006.						
,	action is non-final.						
3) Since this application is in condition for allowan	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.							
Disposition of Claims							
4)⊠ Claim(s) <u>12,13,16,17,21 and 22</u> is/are pending in the application.							
4a) Of the above claim(s) is/are withdrawn from consideration.							
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>12,13,16,17,21 and 22</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and/or	8) Claim(s) are subject to restriction and/or election requirement.						
Application Papers							
9)☐ The specification is objected to by the Examiner.							
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).							
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).							
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.							
Priority under 35 U.S.C. § 119							
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 							
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Do 5) Notice of Informal P 6) Other:						

Application/Control Number: 10/748,480

Art Unit: 2818

DETAILED ACTION

Response to Amendment

Amendment filed on 06/01/2006 has been entered. In Amendment, claims 1-11,
 14, 15 and 18-20 have been cancelled. Claims 12, 13, 16, 17, 21 and 22 are pending in the application.

Allowable Subject Matter

2. The indicated allowability of claim 12 is withdrawn in view of the newly discovered reference(s) to Heo. Rejections based on the newly cited reference(s) follow.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 12, 13, 21 and 22 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tsukamoto., (US Pat No. 5,640,052) in view of Heo., (US Pat No. 6,091,141).

Regarding claim 12, Tsukamoto teaches a circuit board assembly comprising: a circuit board (substrate) 2 comprising a board pad (substrate pad) 6 (col. 3, lines 5-15 and Fig. 1);

Page 2

Art Unit: 2818

a component package (chip) 1, comprising a terminal with a planar base 5 aligned with the board pad 6 (col. 3, lines 5-15 and Fig. 1).

the terminal including a elongated member (core) 4, having an outer surface and a cross section area extending from the terminal base 5 (col. 3, lines 20-26 and Fig. 1); and

a solder 3 deposit having a hourglass shape, covering the pad 6 and the outer surface of the elongated member 4 (col. 3, lines 20-26 and Fig. 1).

Tsukamoto teaches the elongated member (core) 4, but does not teach the elongated member including a J-hook shaped.

However, Heo teaches solder (27) having elongated member (tail) 23 including a J-hook shaped (col. 4, lines 62-67 and Fig. 2A). Since Tsukamoto and Heo are all from the same field of endeavor, the purpose disclosed by Heo would have been recognized in the pertinent art of Tsukamoto. It would have been obvious to a person of ordinary skill in the art at the time of the invention was made to provide a J-hook shaped core in the solder in order to achieve compactness, smallness, lightness and thinness of the semiconductor package as taught by Heo, column 5, lines 15-18.

Regarding claim 13, Tsukamoto teaches wherein the pad 6 has a surface area greater than the cross section area of the elongated member 4 (col. 3, lines 13-15, lines 50-56, Figs. 2a-2c).

Regarding claim 21, Tsukamoto teaches the solder deposit 3 has a length L6 is approximately the length (L2 + L3) of the elongated member 4 (col. 3, lines 30-65, Figs. 2a-2b).

Art Unit: 2818

Regarding claim 22, Tsukamoto teaches the cross section of the solder deposit 3 along its length L5 is smaller than the planar base area of the terminal 5 (col. 3, lines 1-5, lines 40-45 and Fig. 2b).

5. Claims 16 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tsukamoto (US Pat No. 5,640,052) and Heo., (US Pat No. 6,091,141) as applied to claim 12 above, and further in view of Inatsugu (US Pat No. 6,821,820).

Regarding claim 16, Tilly teaches the component or chip package 20 (col. 3, lines 24-26, lines 57-65 and Fig. 3), but does not teach wherein the component package comprises a Quad Flat No-lead (QFN) package.

However, Inatsugu teaches wherein the component package comprises a Quad Flat No-lead (QFN) package (col. 11 lines 48-60). Since Tilly and Inatsugu are all from the same field of endeavor, the purpose disclosed by Inatsugu would have been recognized in the pertinent art of Tilly. It would have been obvious to a person of ordinary skill in the art at the time of the invention was made to provide the component package comprises a Quad Flat No-lead (QFN) package so that the anchor effect can be achieved and thus the coming off of the lead portion form the molding resin can be presented in as taught by Inatsugu, column 11, lines 55-60.

Regarding claim 17, Tilly teaches the component or chip package 20 (col. 3, lines 24-26, lines 57-65 and Fig. 3), but does not teach wherein the component package comprises a Small Outline No-lead (SON) package.

However, Inatsugu teaches wherein the component package comprises a Small Outline No-lead (SON) package (col. 11 lines 48-60). Since Tilly and Inatsugu are all

Art Unit: 2818

from the same field of endeavor, the purpose disclosed by Inatsugu would have been recognized in the pertinent art of Tilly. It would have been obvious to a person of ordinary skill in the art at the time of the invention was made to provide the component package comprises a Small Outline No-lead (SON) package so that the anchor effect can be achieved and thus the coming off of the lead portion form the molding resin can be presented in as taught by Inatsugu, column 11, lines 55-60.

Conclusion

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Quoc Hoang whose telephone number is (571) 272-1780. The examiner can normally be reached on Monday-Friday from 8.00 AM to 5.00 PM.

If attempt to reach the examiner by telephone are unsuccessful, the examiner's supervisor, MinSun Harvey can be reached on (571) 272-1835. The fax phone numbers of the organization where this application or proceeding is assigned are (571) 273-8300 for regular communications and (571) 273-8300 for After Final communications.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Application/Control Number: 10/748,480

Art Unit: 2818

Quoc Hoang Patent examiner/AU 2818

Page 6

Murbon/ 56/05/2006